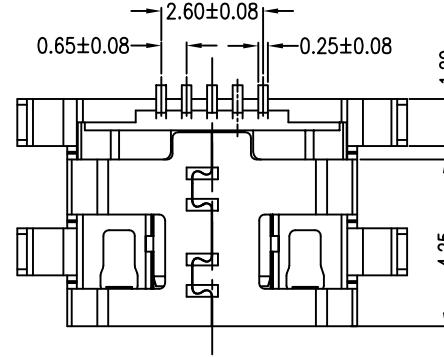
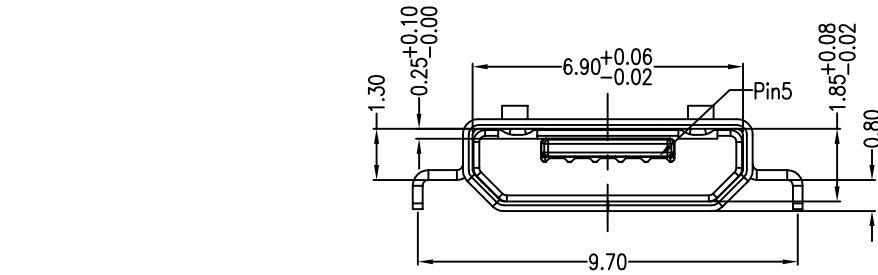


REV.	ECN NO.	CONTENT	DATE	ENGINEER
A0			2023 20/04	



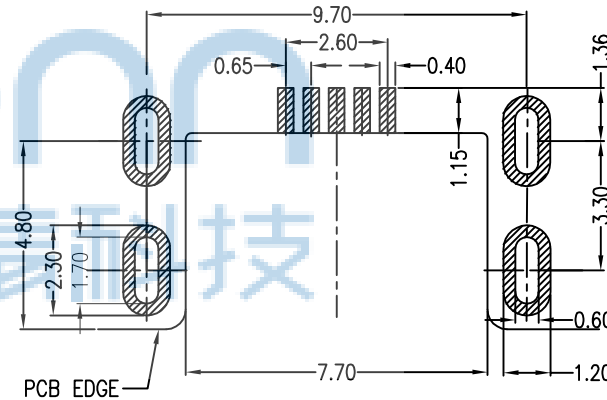
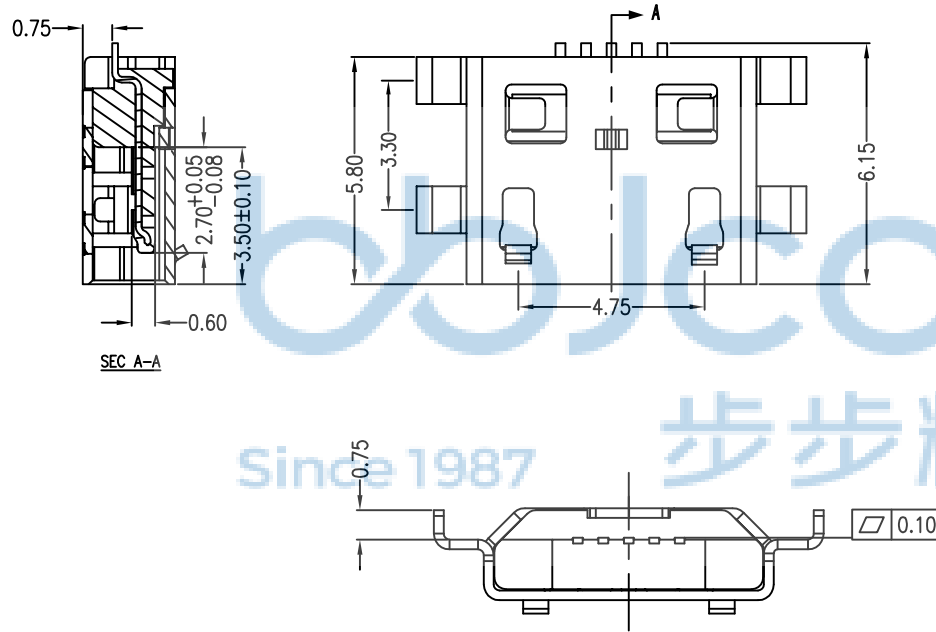
Note:

1.Material:

- 1.1 Housing: High temperature thermoplastic with g.f,UL94v-0; LCP
- 1.2 Contact: copper alloy,t=0.15mm C5191
- 1.3 Shell: copper alloy,t=0.25mm; 外壳不锈钢304

2.Specification:

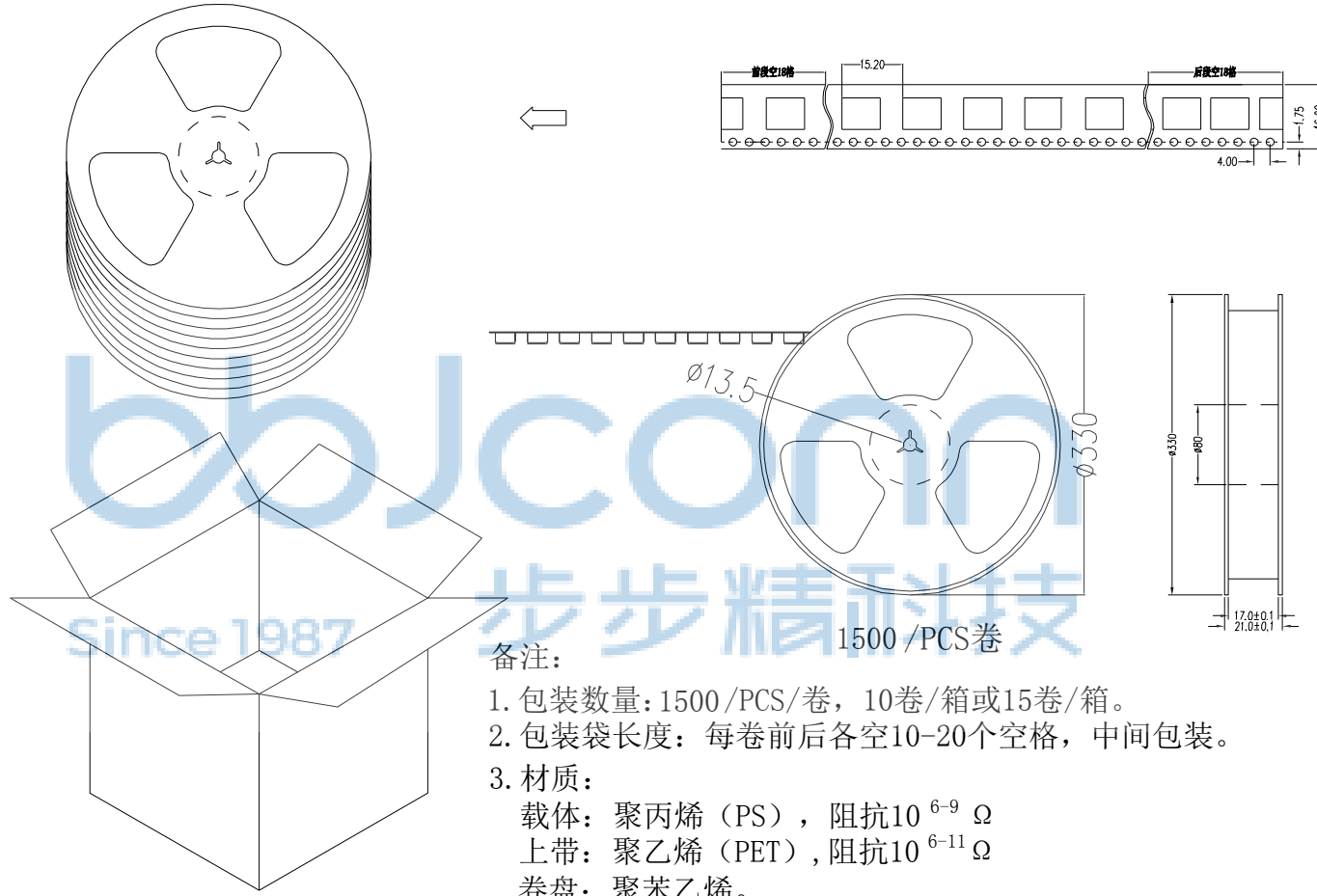
- 2.1 Current rating:1,5PIN 1.8A Max/2,3,4PIN 1A Max.
- 2.2 Dielectric withstanding voltage: 100 V(ac) for 1 min.
- 2.3 Contact resistance: 30 mΩ Max.
- 2.4 Insulation resistance: 100 MΩ Min.
- 2.5 Total mating force: 3.57 Kg Max.
- 2.6 Total unmating force: 1.0 Kg Min.
- 2.7 Temperature range: -30°C~80°C



RECOMMENDED PCB LAYOUT
PCB图仅供参考



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.X: ±0.38 .XX: ±0.25 .XXX: ±0.13		X": ±3" .X": ±2" .XX": ±1"		NAME: Micro 5P B 沉板0.8四脚插端子镀金15U SMT 平口不锈钢外壳			
APPD. JM_Zheng		23/05'02		PJ. NO.: MC.01.72-21-1002			
CHKD. LYX		23/05'02		SIZE: A4 DRW NO.:			
PDWG.NO: 0113-1		DR. SGF		23/05'02		FINISH: SEE NOTES	
						MAT'L.: SEE NOTES	
						SCALE: N/A REV.: A3	
						UNIT: mm	
						PAGE: 1/1	



备注:

1. 包装数量: 1500 /PCS/卷, 10卷/箱或15卷/箱。
2. 包装袋长度: 每卷前后各空10-20个空格, 中间包装。
3. 材质:
载体: 聚丙烯 (PS), 阻抗 $10^{6-9} \Omega$
上带: 聚乙烯 (PET), 阻抗 $10^{6-11} \Omega$
卷盘: 聚苯乙烯。

纸箱规格: 345*345*23MM

纸箱规格: 345*345*35MM



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		APPD.	JM_Zheng	23/05'02		PJ. NO.: MC.01.72-21-1002		
		CHKD.	LYX	23/05'02		SIZE: A4	DRW NO.:	
		FINISH: SEE NOTES		MAT'L.: SEE NOTES				
SCALE: N/A		REV.: A3	UNIT: mm	PAGE: 1/1				